

Customer No.: 31561
Application No.: 10/604,772
Docket No.: 08503-US-PA-0C

REMARKS

Present Status of the Application

The Office Action rejected claims 1, 2, and 6 under 35 U.S.C. 102(a) as being anticipated by Liu (U. S. Patent 6,756,256). The Office Action rejected claims 1-9 as being double patenting with U. S. Patent No. 6,756,256. Applicants have submitted the "*Terminal Disclaimer*" to overcome double patenting. Claims 1-9 remain pending in the present application, and reconsideration of those claims is respectfully requested.

Double Patenting

A terminal disclaimer has been submitted to overcome double patenting with U. S. Patent No. 6,756,256 with respect claims 1-9.

Discussion of Claim Rejections under 35 USC 102

The Office Action rejected claims 1, 2, and 6 under 35 U.S.C. 102(a) as being anticipated by Liu. Applicants respectfully traverse the rejections for at least the reasons set forth below.

In the present invention, as for example shown in FIG. 1E, the dielectric layer 150 is substantially above the burnt fuse pad and fills the gap.

In re Liu, in FIG. 14, the passivation layer 308 does not filled the gap 314. In FIG. 4, the passivation layer 116 is formed over the substrate 100 and just exposes the bonding pad 102.

Liu does not equally disclose features of the claimed invention.

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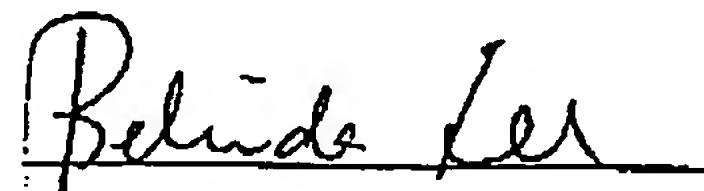
For at least the foregoing reasons, Applicant respectfully submits that independent claims 1 and 6 patently define over the prior art references, and should be allowed. For at least the same reasons, dependent claims 2-5 and 7-9 patently define over the prior art references as well.

CONCLUSION

For at least the foregoing reasons, it is believed that all the pending claims 1-9 of the invention patently define over the prior art and are in proper condition for allowance. If the Examiner believes that a telephone conference would expedite the examination of the above-identified patent application, the Examiner is invited to call the undersigned.

Date :

March 16, 2005



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